



**Pb-free
HEAT**

STANLEY

U□1114C-0005 Series

Single Color 1608 (h=0.4 mm) Type

Features

Package	1608 (h=0.4mm) Type, Milky White resin
Product features	• Outer Dimension 1.6 x 0.8 x 0.4mm (L x W x H) • Temperature range Storage Temperature : -40℃~100℃ Operating Temperature : -40℃~ 85℃ • Lead-free soldering compatible • RoHS compliant
Dominant wavelength	Blue : 470nm(UB) Green : 527nm(UG)
Spatial distribution	$\theta_x = 133 \text{ deg.}, \theta_y = 144 \text{ deg.}$
Die materials	InGaN
Rank grouping parameter	Sorted by luminous intensity and wavelength per rank taping
Assembly method	Auto pick & place machine (Auto Mounter)
Soldering methods	Reflow soldering and manual soldering
Taping and reel	4,000pcs per reel in a 8mm width tape. (Standard) Reel diameter: $\phi 180\text{mm}$
ESD	1kV (HBM)

Recommended Applications

Cellular Phone only

Color and Luminous Intensity

(Ta=25°C)

Part No.	Material	Emitted Color	Lens Color	Dominant Wavelength λd (nm)		Luminous Intensity I_v (mcd)		
				TYP.	I_F	MIN.	TYP.	I_F
UB1114C-0005	InGaN	Blue	Milky White	470	5	6	16	5
UG1114C-0005	InGaN	Green		527	5	16	40	5

※Note : The luminous intensity(I_v) and dominant wavelength (λd) above are the setup values of the sorting machine.
 (Tolerance : $I_v \dots \pm 10\%$, $\lambda d \dots \pm 3\text{nm}$)

Absolute Maximum Ratings

(Ta=25°C)

Item	Symbol	Absolute Maximum Ratings		Unit
		UB	UG	
Power Dissipation	P_d	70	76	mW
Forward Current	I_F	20	20	mA
Pulse Forward Current ※1	I_{FRM}	48	48	mA
Derating (Ta=25°C or higher)	ΔI_F	0.28	0.28	mA/°C
	ΔI_{FRM}	0.69	0.69	mA/°C
Reverse Voltage	V_R	5	5	V
Operating Temperature	T_{opr}	-40~+85		°C
Storage Temperature	T_{stg}	-40~+100		°C

※1 I_{FRM} Measurement condition : Pulse Width ≤ 1 ms., Duty $\leq 1/20$.

Electro-Optical Characteristics

(Ta=25°C)

Item	Conditions	Symbol	Characteristics			Unit
				UB	UG	
Forward Voltage	I _F =5mA	V _F	TYP.	2.9	2.9	V
			MAX.	3.2	3.3	
Reverse Current	V _R =5V	I _R	MAX.	100	100	μ A
Peak Wavelength	I _F =5mA	λ _p	TYP.	466	522	nm
Dominant Wavelength	I _F =5mA	λ _d	TYP.	470	527	nm
Spectral Line Half Width	I _F =5mA	Δλ	TYP.	30	35	nm
Half Intensity Angle	I _F =5mA	2θ _{1/2}	TYP.	133(θ _x)	133(θ _x)	deg.
				144(θ _y)	144(θ _y)	

※Note: The dominant wavelength (λ_d) above is the setup value of the sorting machine.
(Tolerance: λ_d ...±3nm)

Luminous Intensity Rank

(Ta=25°C)

Intensity Tolerance each Rank : +/- 10%

Rank	I _V (mcd)			
	UB		UG	
	I _F =5mA		I _F =5mA	
	MIN.	MAX.	MIN.	MAX.
A	6	10	16	25
B	10	16	25	40
C	16	25	40	64
D	25	40	64	100
E	40	-	100	-

※ Please contact our sales staff concerning rank designation.

Color Tone Groups (λ d)

(Ta=25°C)

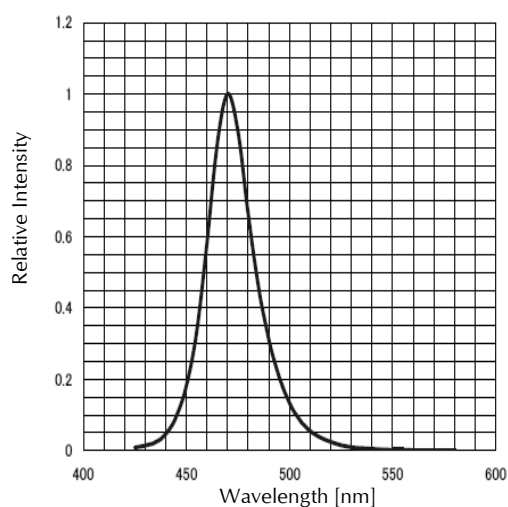
Tolerance: +/- 3nm

Rank	Dominant Wavelength λ d (nm)			
	UB		UG	
	I _F =5mA		I _F =5mA	
	MIN.	MAX.	MIN.	MAX.
1			515	527
2	465	470	527	540
3	470	475		

※ Please contact our sales staff concerning rank designation.

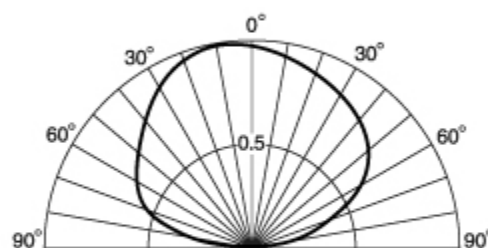
Technical Data(UB)

Spectral Distribution
Relative Intensity vs. Wavelength
Condition : $T_a = 25^\circ\text{C}$, $I_f = 5\text{mA}$

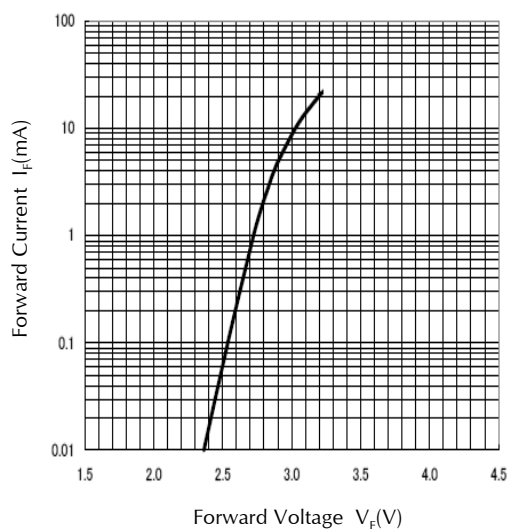


Spatial Distribution Example

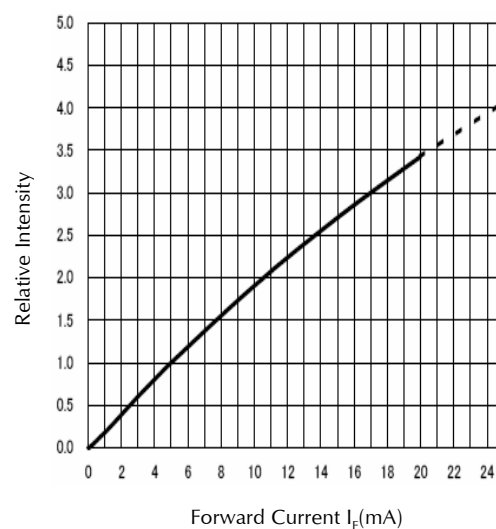
Condition : $T_a = 25^\circ\text{C}$



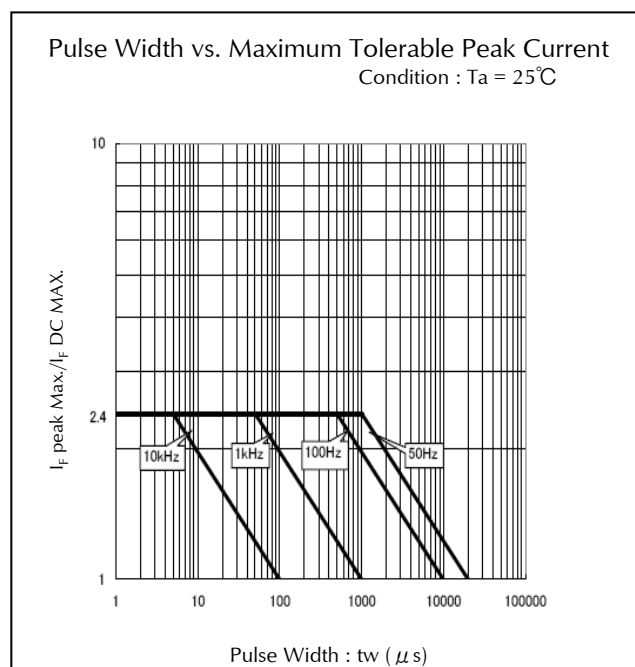
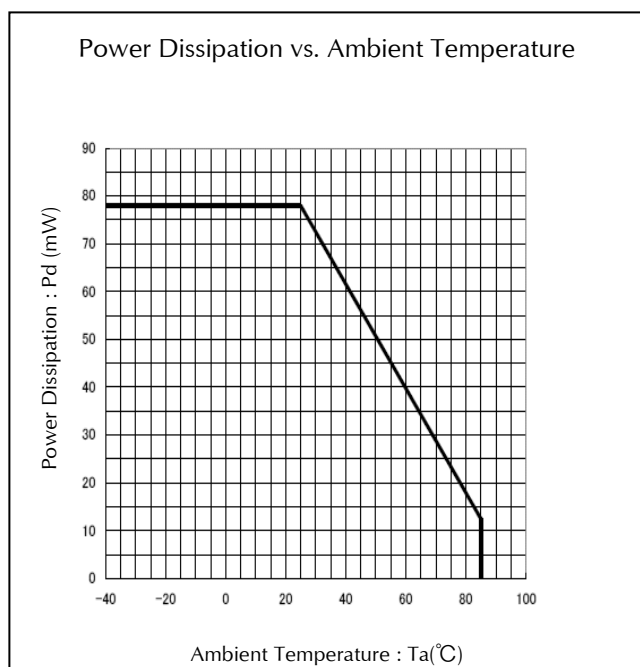
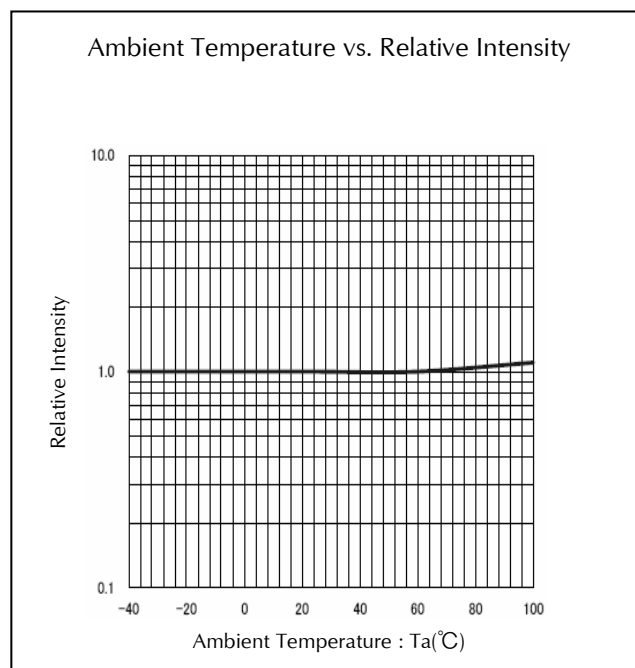
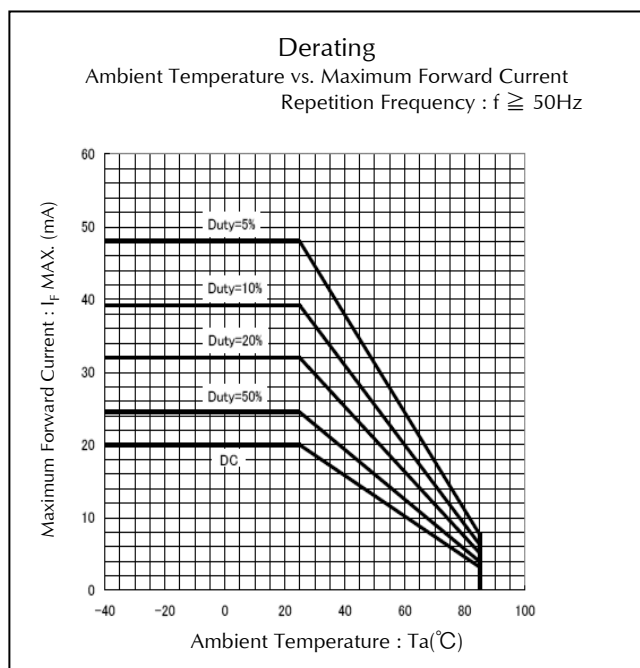
Forward Voltage vs. Forward Current
Condition : $T_a = 25^\circ\text{C}$



Forward Current vs. Relative Intensity
Condition : $T_a = 25^\circ\text{C}$

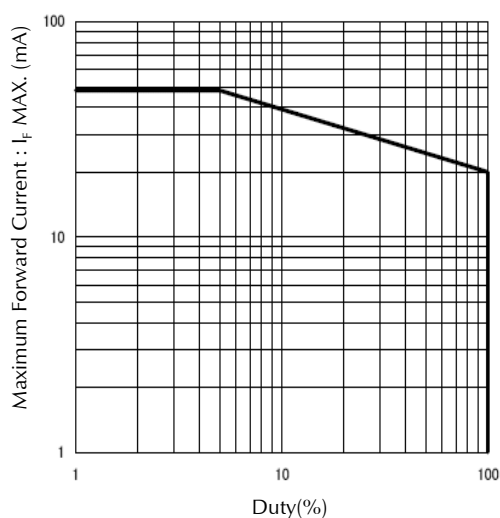


Technical Data(UB)

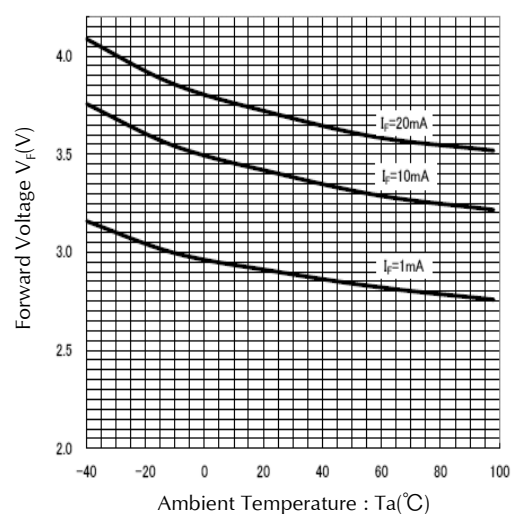


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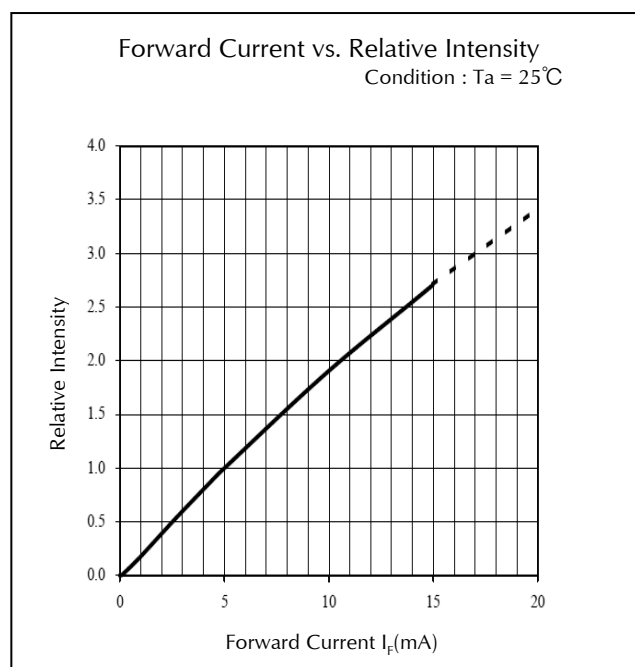
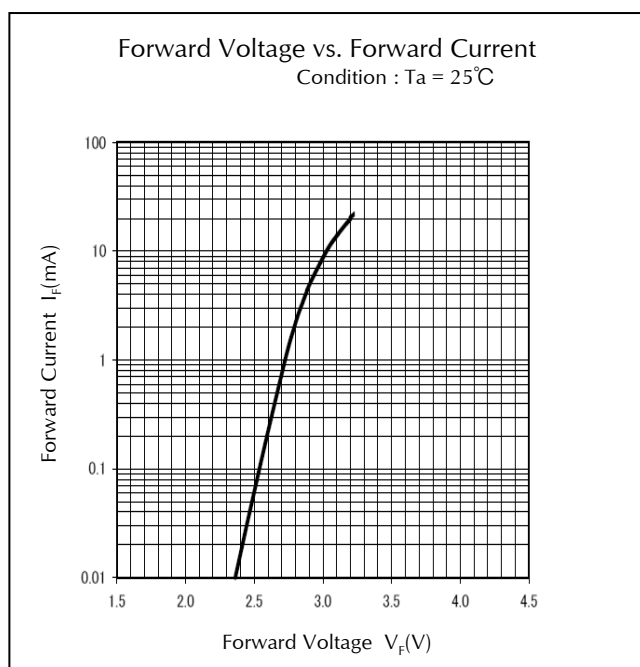
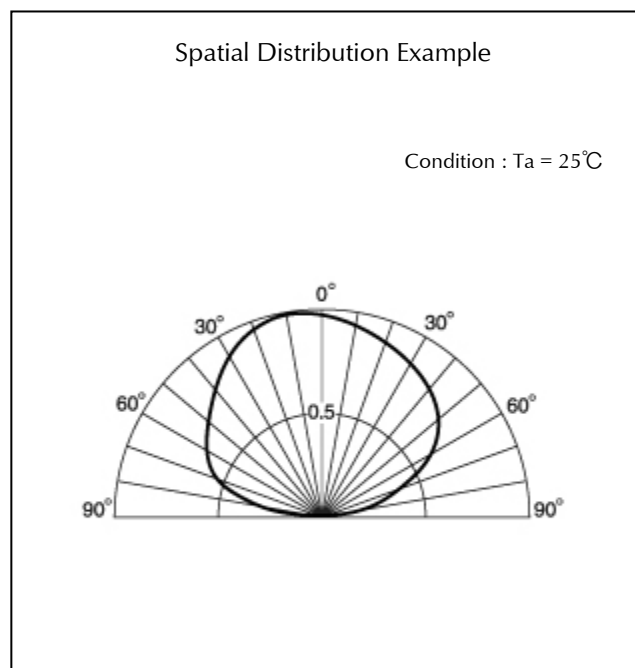
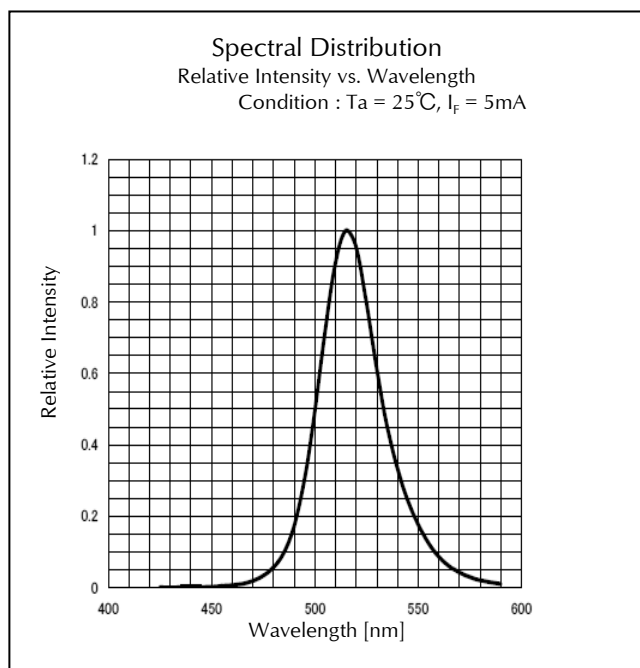
Duty Cycle vs. Maximum Forward Current



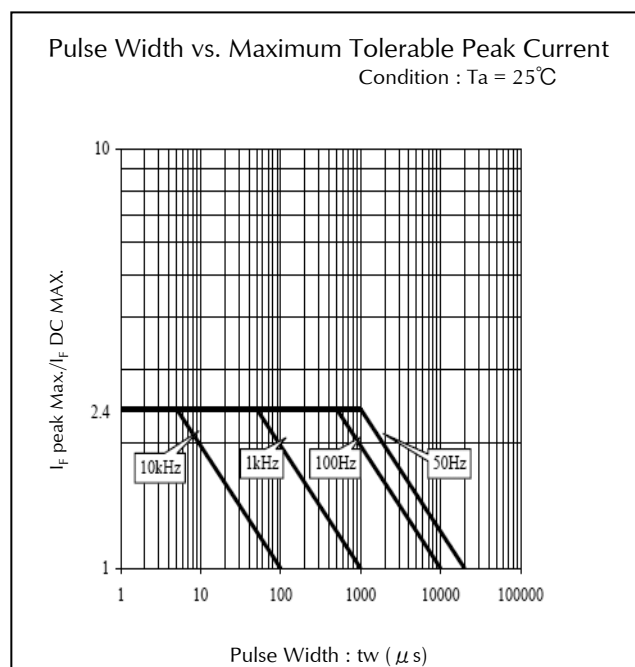
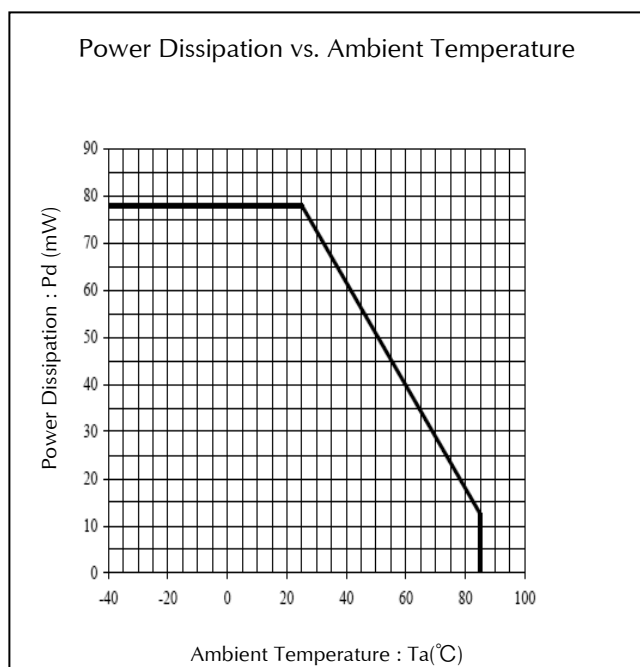
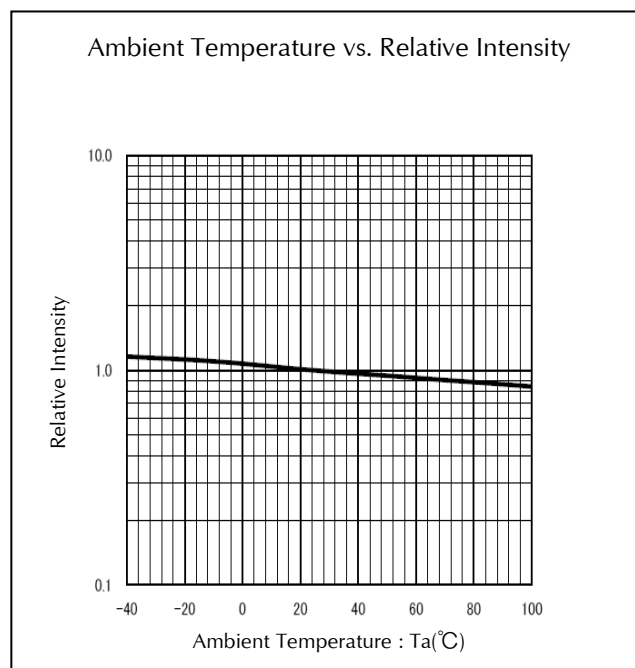
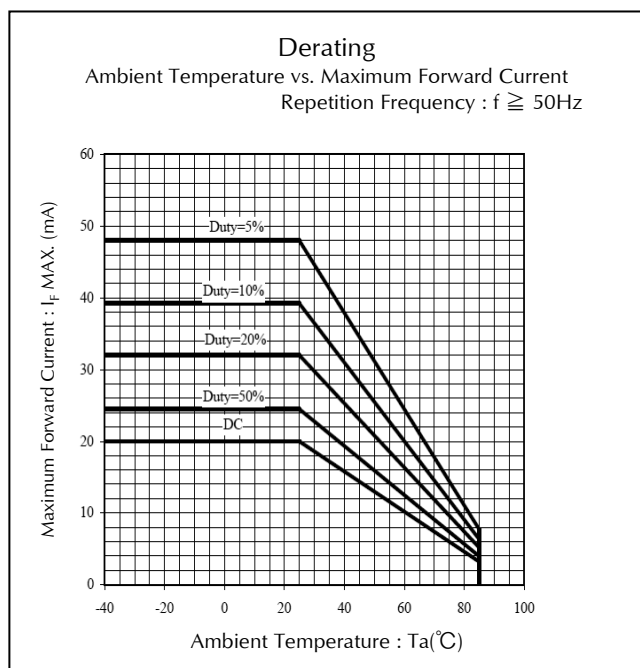
Ambient Temperature vs. Forward Voltage



Technical Data(UG)

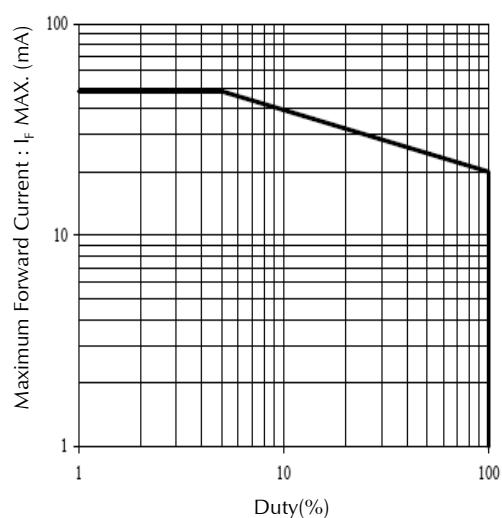


Technical Data(UG)

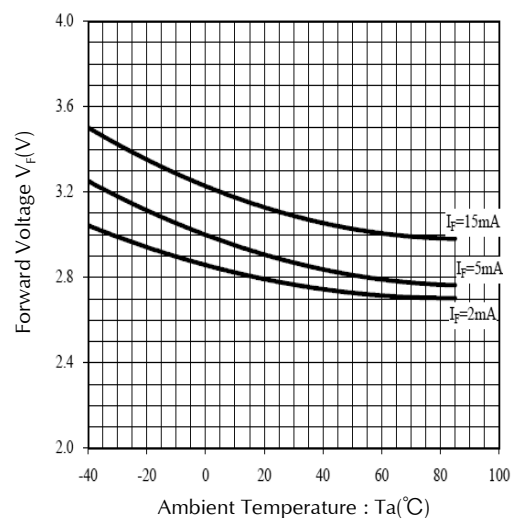


Technical Data(UG)

Duty Cycle vs. Maximum Forward Current



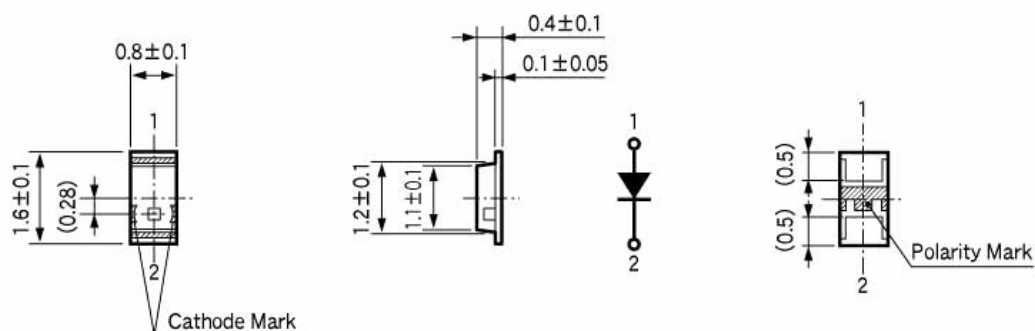
Ambient Temperature vs. Forward Voltage



Package Dimensions

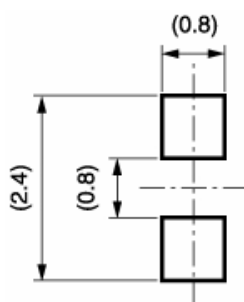
(Unit: mm)

Weight: (1.32)mg



Recommended Soldering Pattern

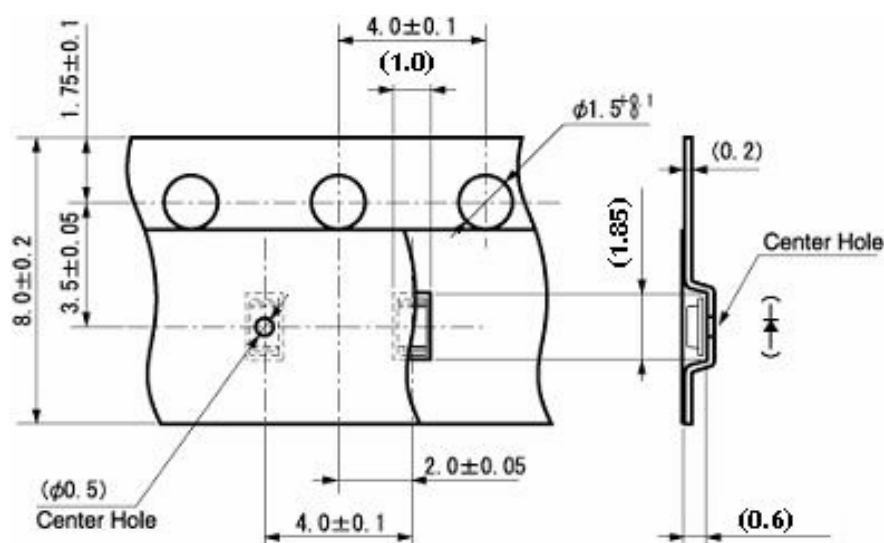
(Unit: mm)



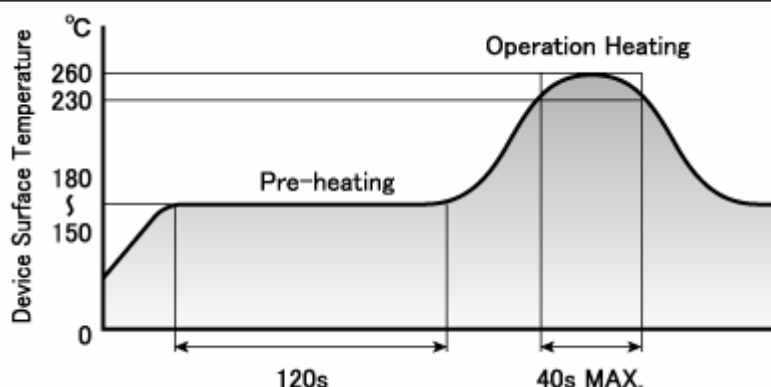
Taping Specification

(Unit: mm)

Quantity : 4,000pcs/ reel (standard)



Reflow Soldering Conditions



- 1) The above profile temperature gives the maximum temperature of the LED resin surface. Please set the temperature so as to avoid exceeding this range.
- 2) Total times of reflow soldering process shall be no more than 2 times. When the second reflow soldering process is performed, intervals between the first and second reflow should be short as possible (while allowing some time for the component to return to normal temperature after the first reflow) in order to prevent the LED from absorbing moisture.
- 3) Temperature fluctuation to the LED during the pre-heating process shall be minimized. (6°C maximum)

Manual Soldering Conditions

Iron tip temp.	350 °C	(MAX.)
Soldering time and frequency	3 s	(MAX.)
	1 time	(MAX.)

Handling

These types are designed chiefly for Cellular phone application, and are setting the thickness of the Product to about 0.4-0.5 mm thinly. To achieve the tin type of the product, making each material thin is aimed at. Because they are inferior to our general LEDs by an external stress, please use these product types after paying attention to the following.

- 1) Please set the mounting load to Max. 2N.
- 2) Please do not increase more quantity of the soldering paste than necessary quantity
(The thickness of stencil Mask : about 100-120 μ), because the terminal area of the product is small.
- 3) Please avoid the collision of the mounting board etc. after LEDs were mounted on the substrate.
- 4) When warp of substrate is large after these were mounted on FPC etc, please use these product types after affirming these is no problem.
- 5) Please use these product types after affirming there is no problem about the mounting position etc. of product from substrate edge, when mounting them on multi-layer and multi-piece PCBs.

Reliability Testing Result

Reliability Testing Result	Applicable Standard	Testing Conditions	Duration	Failure
Room Temp. Operating Life	EIAJ ED-4701/100(101)	Ta = 25°C, If = Maximum Rated Current	1,000 h	0/25
Resistance to Soldering Heat	EIAJ ED-4701/300(301)	Pre-heating : 150~180°C 120s Max. Operation Heating : 230°C 40s Max. Peak Temperature : 260°C	Twice	0/25
Temperature Cycling	EIAJ ED-4701/100(105)	Minimum Rated Storage Temperature(30min) ~Normal Temperature(15min) ~Maximum Rated Storage Temperature(30min) ~Normal Temperature(15min)	5 cycles	0/25
Wet High Temp. Storage Life	EIAJ ED-4701/100(103)	Ta = 60±2°C, RH = 90±5%	1,000 h	0/25
High Temp. Storage Life	EIAJ ED-4701/200(201)	Ta = Maximum Rated Storage Temperature	1,000 h	0/25
Low Temp. Storage Life	EIAJ ED-4701/200(202)	Ta = Minimum Rated Storage Temperature	1,000 h	0/25
Vibration, Variable Frequency	EIAJ ED-4701/400(403)	98.1m/s ² (10G), 100 ~ 2KHz sweep for 20min., XYZ each direction	2 h	0/10

Failure Criteria

Items	Symbols	Conditions	Failure criteria
Luminous Intensity	Iv	If Value of each product Luminous Intensity	Testing Min. Value < Spec. Min. Value x 0.5
Forward Voltage	V _F	If Value of each product Forward Voltage	Testing Max. Value ≥ Spec. Max. Value x 1.2
Reverse Current	I _R	V _R = Maximum Rated Reverse Voltage V	Testing Max. Value ≥ Spec. Max. Value x 2.5
Cosmetic Appearance	-	-	Occurrence of notable decoloration, deformation and cracking

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